Specification of Thermoelectric Module

TEC1-12708

Description

The 127 couples, 40 mm × 40 mm size single stage module is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 70, designed for superior cooling and heating up to 100 °C requirement. It has higher cooling efficiency than normal type module. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- High effective cooling and efficiency.
- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly, RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

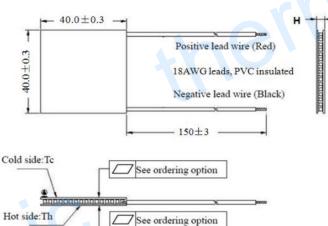
Performance Specification Sheet

Application

- Food and beverage service refrigerator
- Photonic and medical systems
- Portable cooler box for cars
- Temperature stabilizer
- Liquid cooling

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	70	79	Temperature Difference between cold and hot side of the module	
			when cooling capacity is zero at cold side	
U _{max} (Voltage)	16.2	17.3	Voltage applied to the module at DT _{max}	
I _{max} (amps)	8.2	8.2	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	81.7	88.8	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance (ohms)	1.48	1.61	The module resistance is tested under AC	
Tolerance (%)	± 10		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters



See ordering option A

Manufacturing Options

- 1. T100: BiSn (Tmelt=138°C)
- 2. T200: CuAgSn (Tmelt = 217°C)
- 3. T240: SbSn (Tmelt = 240° C)
- C. Ceramics:

A. Solder:

- 1. Alumina (Al₂O₃, white 96%)
- 2. Aluminum Nitride (AlN)

- **B. Sealant:**
- 1. NS: No sealing (Standard)
- 2. SS: Silicone sealant
- 3. EPS: Epoxy sealant
- **D.** Ceramics Surface Options:
- 1. Blank ceramics (not metalized)
- 2. Metalized

Ordering Option						
Suffix	Thickness	Flatness/	Lead wire length(mm)			
	(mm)	Parallelism (mm)	Standard/Optional length			
TF	0:3.5±0.1	0:0.08/0.08	150±3/Specify			
TF	1:3.5±0.03	1:0.03/0.03	150±3/Specify			
Eg. TF01: Thickness 3.5 ± 0.1 (mm) and Flatness $0.03 / 0.03$ (mm)						

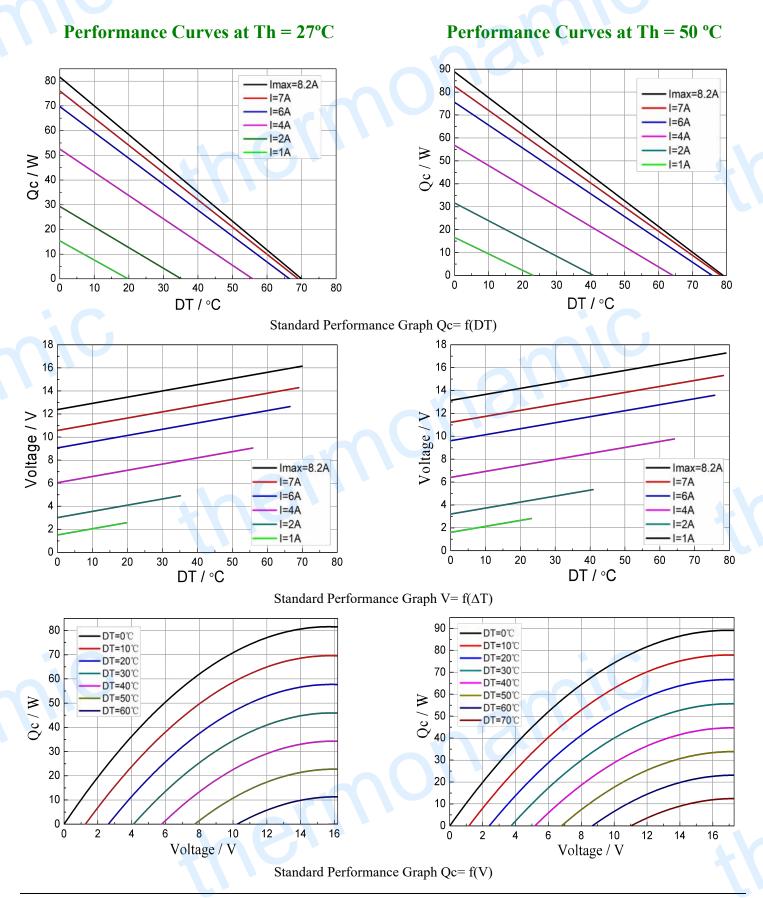


AlO: Alumina white 96% NS: No sealing TF00: Thickness ±0.1(mm) and Flatness/Parallelism 0.035/0.035(mm)

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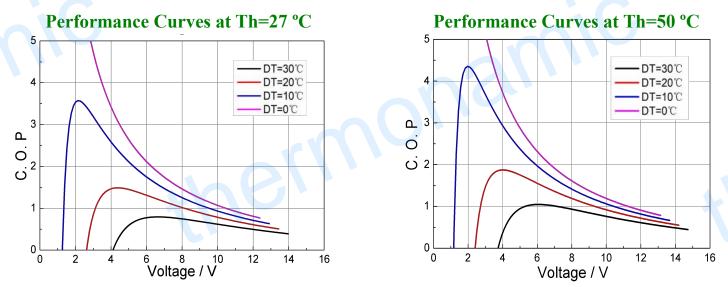
TEC1-12708



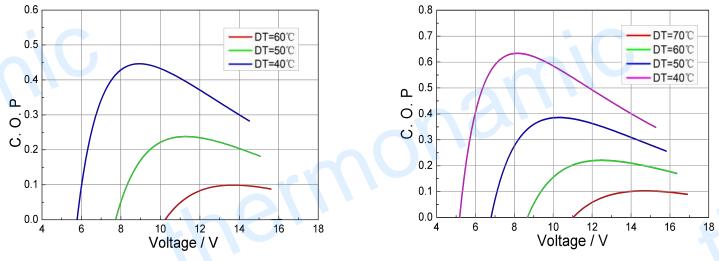
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Standard Performance Graph COP = f(V) of ΔT ranged from 0 to 30 °C



Standard Performance Graph COP = f(V) of ΔT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V × I).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- nonanic • Attach the hot side of module to a heat radiator for heat dissipating
- Operation or storage module below 100 °C
- Operation below I_{max} or V_{max}
- Work under DC